V30KM120

Vishay General Semiconductor

High Current Density Surface-Mount (TMBS[®]) Trench MOS Barrier Schottky Rectifier

Ultra Low $V_F = 0.43$ V at $I_F = 5$ A



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1, 2, 3, 4 • 5, 6, 7, 8

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS						
I _{F(AV)}	30 A					
V _{RRM}	120 V					
I _{FSM}	240 A					
V_F at I_F = 30 A (T_J = 125 °C)	0.67 V					
T _J max.	165 °C					
Package	FlatPAK 5 x 6					
Circuit configuration	Single					

FEATURES

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



AUTOMOTIVE GRADE

Available

- AEC-Q101 qualified available - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	V30KM120	UNIT		
Device marking code		30M12			
Maximum repetitive peak reverse voltage	V _{RRM}	120	V		
Maximum DC forward current	I _{F(AV)} ⁽¹⁾	30			
	I _{F(AV)} ⁽²⁾	4.1	A		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	240			
Operating junction temperature range	T _J ⁽³⁾	-40 to +165			
Storage temperature range	T _{STG}	-55 to +165	U U		

Notes

⁽¹⁾ With infinite heatsink

⁽²⁾ Free air, mounted on recommended pad area

⁽³⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{0,JA}$

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ELECTRICAL CHARACTERISTICS ($T_J = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 5 A	5 A T _J = 25 °C	- V _F (1)	0.52	-	V
	I _F = 15 A			0.67	-	
	I _F = 30 A			0.86	0.93	
	I _F = 5 A	T _J = 125 °C		0.43	-	
	I _F = 15 A			0.56	-	
	I _F = 30 A			0.67	0.72	
Reverse current	V _R = 90 V	T _J = 25 °C	I _R (2)	0.007	-	mA
	$v_{\rm R} = 90 v$	T _J = 125 °C		4	-	
	V _R = 120 V	T _J = 25 °C		-	0.7	
	v _R = 120 v	T _J = 125 °C		7	35	
Typical junction capacitance	4.0 V, 1 MHz		CJ	2500	-	pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Thermal resistance	R _{0JA} (1)(2)	75	-	°C/W		
mermanesistance	R _{0JM} ⁽³⁾	2.5	3.5			

Notes

 $^{(1)}$ The heat generated must be less than thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{\theta JA}$

⁽²⁾ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction-to-ambient

 $^{(3)}$ Mounted on infinite heatsink; thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
V30KM120-M3/H	0.10	Н	1500	7" diameter plastic tape and reel			
V30KM120-M3/I	0.10	I	6000	13" diameter plastic tape and reel			
V30KM120HM3/H ⁽¹⁾	0.10	Н	1500	7" diameter plastic tape and reel			
V30KM120HM3/I (1)	0.10	I	6000	13" diameter plastic tape and reel			

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

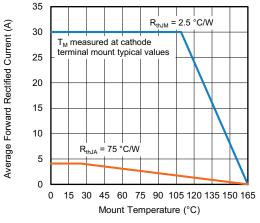


Fig. 1 - Maximum Forward Current Derating Curve

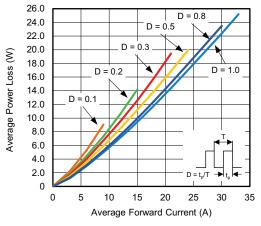


Fig. 2 - Forward Power Loss Characteristics

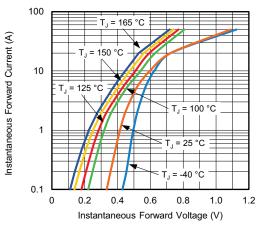


Fig. 3 - Typical Instantaneous Forward Characteristics

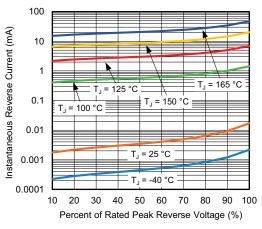
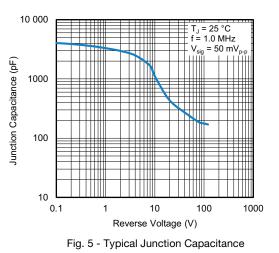


Fig. 4 - Typical Reverse Leakage Characteristics



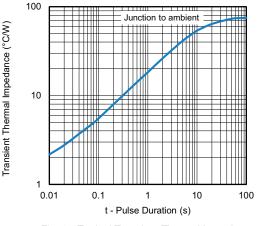


Fig. 6 - Typical Transient Thermal Impedance

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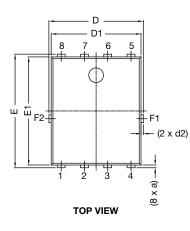
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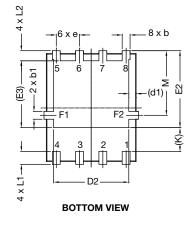


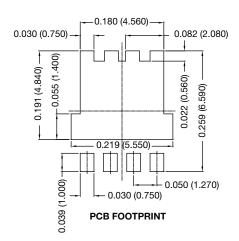
DIMENSIONS in inches (millimeters)

ISHAY

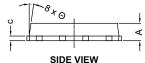
FlatPAK 5 x 6







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DIM		INCHES		MILLIMETERS		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
А	0.035	0.039	0.043	0.89	0.99	1.09
(a)	-	0.006	-	-	0.15	-
b	0.013	0.017	0.020	0.32	0.43	0.52
b1	0.013	0.017	0.020	0.32	0.43	0.52
С	0.008	-	0.014	0.20	-	0.35
D	0.197	0.203	0.209	5.00	5.15	5.30
D1	0.189	0.193	0.197	4.80	4.90	5.00
D2	0.154	0.161	0.169	3.90	4.10	4.30
(d1)	-	0.016	-	-	0.40	-
(d2)	-	0.005	-	-	0.125	-
E	0.238	0.244	0.250	6.05	6.20	6.35
E1	0.228	0.232	0.236	5.80	5.90	6.00
E2	0.157	0.165	0.173	4.00	4.20	4.40
(E3)	-	0.144	-	-	3.65	-
е		0.050 BSC			1.27 BSC	
(K)	0.039	-	-	1.00	-	-
L1	0.019	-	0.043	0.48	-	1.10
L2	0.012	-	0.031	0.30	-	0.80
М	0.128	0.138	0.148	3.25	3.50	3.75
Θ	0°	-	10°	0°	-	10°

Notes

Dimensioning and tolerancing per ASME Y14.5-2009

• Dimensions D1 and E1 do not include mold flash or gate burrs

• Dimension (XX) means reference only

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